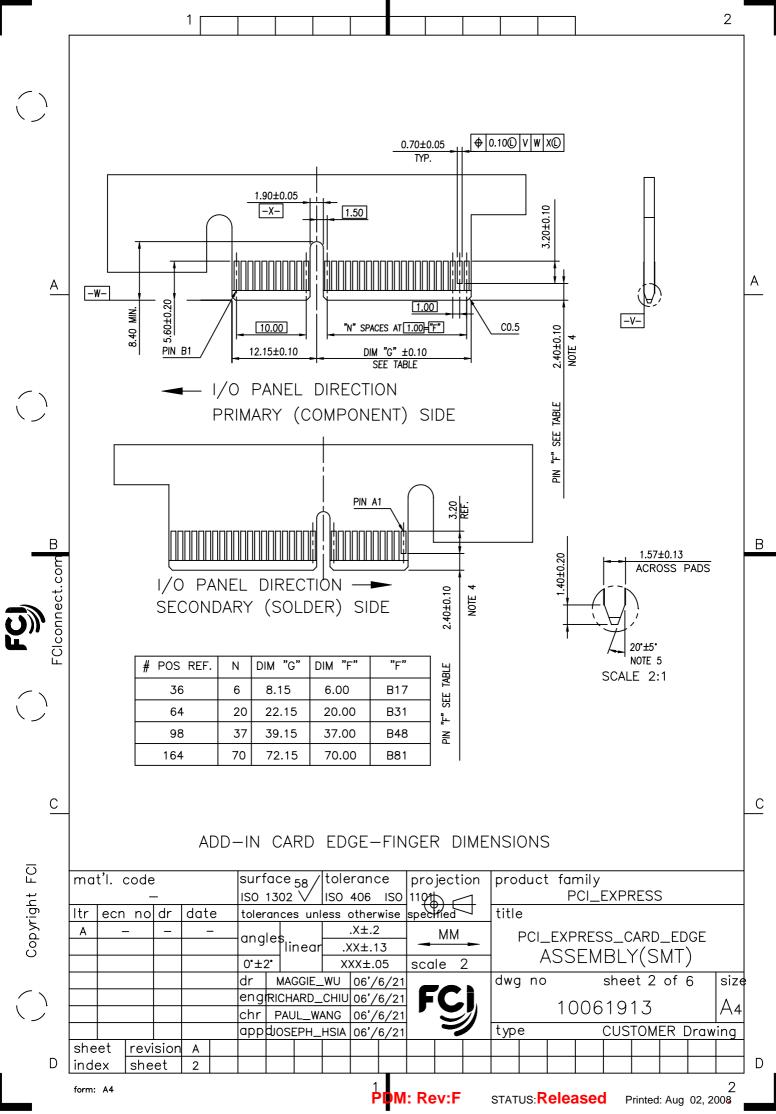


STATUS: Released

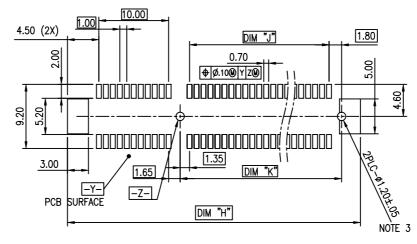




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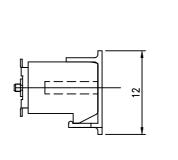
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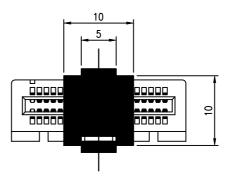


RECOMMENDED PCB LAYOUT, PAD TYPE

DIMENSIONS													
POSITION	Α	B ±0.15 -0.05	C ±0.20	D ±0.23	E ±0.20	H ±0.10	J	K ±0.10					
36	6.00	7.65	9.15	25.00	27.00	28.00	6.00	9.15					
64	20.00	21.65	23.15	39.00	41.00	42.00	20.00	23.15					
98	37.00	38.65	40.15	56.00	58.00	59.00	37.00	40.15					
164	70.00	71.65	73.15	89.00	91.00	92.00	70.00	73.15					

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	_																1	PCI_EXPRESS					
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						0°±2				XX±.	05	sca	le 2	2	ASSEMBLI (SMI)								
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STATUS: Released

NOTES:

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1.MATERIAL:

HOUSING: NYLON, GLASS FILLED UL94V-O RATE, SUITABLE FOR I.R SOLDERING.

TERMINAL: COPPER ALLOY

PLATING: 50u" NICKEL UNDERPLATE ALL OVER

CONTACT AREA PLATING — SEE PRODUCT NUMBER CODE SOLDER TAIL: TIN 100u" OVER 50u" NICKEL

METAL PADS: COPPER ALLOY FINISH: 100u" TIN OVER 50u" NICKEL 2.PRODUCT SPECIFICATION: GS-12-390

3THE HORIZONTAL AXIS FOR THE PAD PATTERN IS ESTABLISHED BY

A LINE THROUGH THE CENTER OF THE TWO Ø1.0 HOLES.

THE VERTICAL AXIS IS 90° TO THE HORIZONTAL AXIS, THROUGH THE CENTER OF DATUM -Z-

4NO TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR

PINS A1. (5) CHAMFER EDGES MUST BE FREE OF CUTTING BURRS.

7.RoHS COMPATIBLE PRODUCT SPECIFICATIONS

- PLATING:

- "LF" MEANS THE PRODUCT IS LEAD-FREE, 2um MINIMUM MATTE TIN OVER 1.27um MINIMUM NICKEL UNDERPLATE.
- b MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C±5°C PEAK TEMPERATURE FOR 5 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.

PRODUCT NUMBER CODE

10061913-***

HOUSING COLOR OPTIONS

0-WHITE 1-BLACK

LEAD FREE

PACKAGING OPTIONS

-TRAY PACKAGING WITHOUT CAP -TAPE & REEL PACKING WITHOUT CAP (FOR 36P&64P OPTIONS ONLY)

-TAPE & REEL PACKING WITH CAP (FOR 36P&64P OPTIONS

C-TRAY PACKAGING WITH CAP (FOR 36,64,98P OPTIONS ONLY)

TERMINAL PLATING OPTIONS

0-50u" NI UNDERPLATE
30u" Au CONTACT AREA
100u" TIN TAIL AREA

---- COMPATIBLE RoHS

–50u" Ni UNDERPLATE 15u" Au CONTACT AREA 100u" TIN TAIL AREA –-

-- COMPATIBLE RoHS

2-50u" Ni UNDERPLATE

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revision

sheet

GOLD FLASH CONTACT AREA 100u" TIN TAIL AREA ---- COMPATIBLE ROHS

POS OPTIONS

0 - 36

1 - 64

2 - 98

3 - 164

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duct family PCI_EXPRESS

PCI_EXPRESS_CARD_EDGE ASSEMBLY(SMT)

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sheet4 of 6 size

10061913

type CUSTOMER Drawing

form: A4

PDM: Rev:F

STATUS: Released

Printed: Aug 02, 2008

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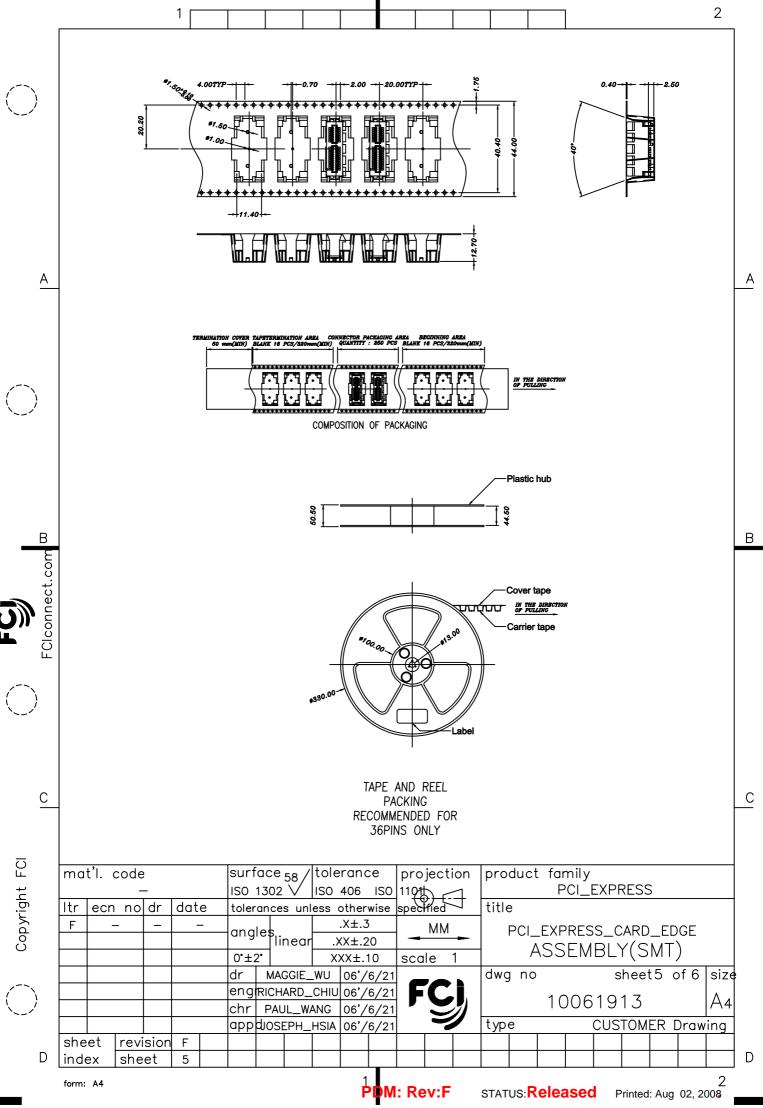
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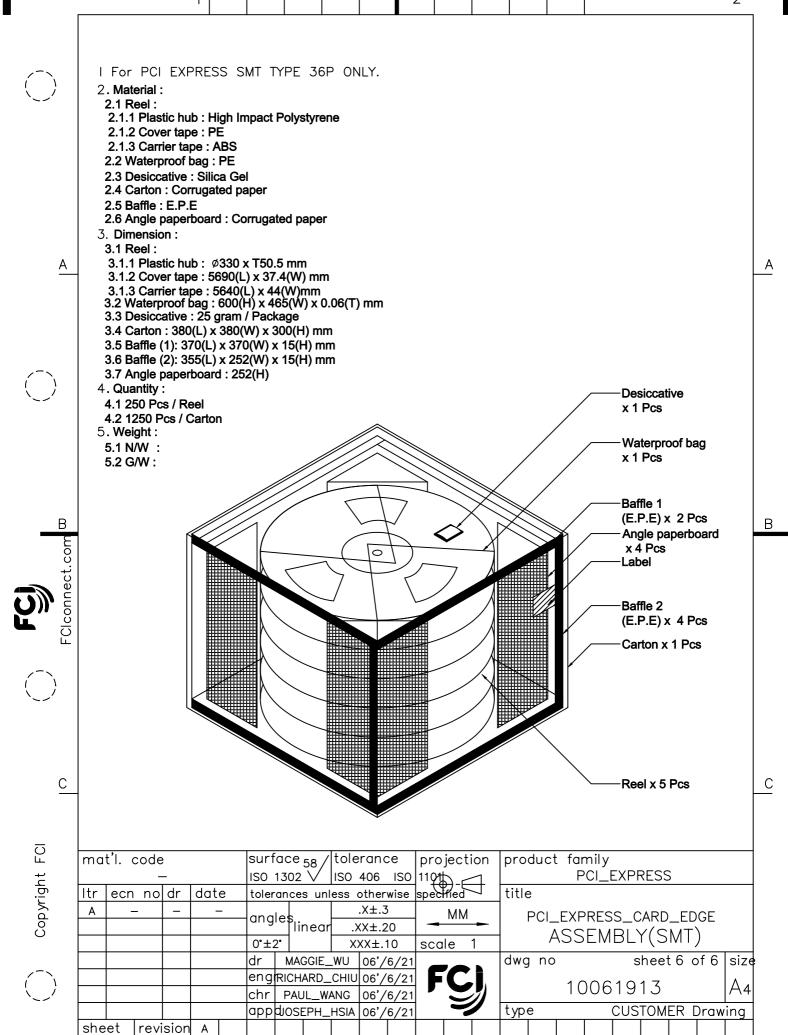
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form: A4

STATUS: Released

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PDM: Rev:F

Printed: Aug 02, 2008

STATUS: Released

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